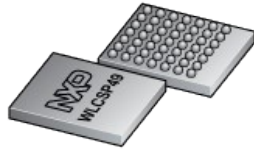




TFA9911UK(No Longer Manufactured)

Package [WLCSP](#) wafer level chip-scale package; 49 bumps; 2.98 x 3.43 x 0.56 mm



- [Buy Options](#) | [Operating Characteristics](#) | [Environmental Information](#) | [Quality Information](#) | [Shipping Information](#)

Buy Options

TFA9911UK/N1Z
 935307508062
 No Longer Manufactured
[REEL-Reel 7" Q1/T1 in Drypack](#)

Min. Package Quantity: 2000

1 @ US

Operating Characteristics

No information available

Environmental Information

Material Declaration	PbFree	EU RoHS	Halogen Free	RHF Indicator	REACH SVHC	Weight (mg)
TFA9911UK/N1Z(935307508062)	Yes	Yes	Yes	D	REACH SVHC	8.779988016

Quality Information

Material Declaration	Safe Assure Functional Safety	Moisture Sensitivity Level (MSL)		Peak Package Body Temperature (PPT) (C°)	
		Lead Soldering	Lead Free Soldering	Lead Soldering	Lead Free Soldering
TFA9911UK/N1Z (935307508062)	No	1	1	240	260

Shipping Information

Part Number	Harmonized Tariff (US) Disclaimer
TFA9911UK/N1Z (935307508062)	854233



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